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PATENT

**AP20 Rec'd PCT/PTO 31 MAY 2006**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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Serial No. : Not Yet Assigned

For : ULTRA-LOW DIELECTRICS FILM FOR COPPER  
INTERCONNECT

Filed :

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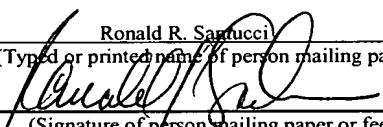
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**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
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Dear Sir:

Prior to the examination of the above referenced patent application, Applicants respectfully request that the application be amended as follows: